## **Xynergy**<sup>XS</sup> Versatile Controller module with STM32 Cortex-M4 Spartan-6 FPGA, 128MB DDR3, 10/100 Ethernet, CAN, UART, USB-OTG, SDIO, I<sup>2</sup>C, ADC/DAC

**Xynergy**<sup>xs</sup> combines STMicroelectronics' STM32F417 controller, based on ARM® Cortex<sup>™</sup>-M4, with a Xilinx Spartan-6 low-cost FPGA XC6SLX16 The controller's FSMC interface is used for parallel 16-bit connection to the FPGA ensuring high-speed data transfer between the two devices. The STM32F417 core can be clocked at up to 168 MHz and has up to 1 MB on-chip flash and 192 KB on-chip SRAM. In addition, the 1Gb (64M x 16) DDR-3 memory, which is connected to the FPGA, can be made transparent via the FSMC bus, allowing the controller to use it like external memory.

The micro-controller of the **Xynergy**<sup>xs</sup> provides numerous communications interfaces, including 10/100 Ethernet with PHY, USB-OTG, CAN (two channels), one SPI, one COM-Port (RX/TX only), I<sup>2</sup>C (two channels), an SDIO port, seven ADC channels, two DAC channels and up to 21 general purpose I/O lines. All interface signals are available at the 200-pin SO-DIMM edge connector.



STM32F417 Block Diagram

The FPGA expands I/O capabilities of the **Xynergy**<sup>XS</sup> by delivering up to 35 differential (LVDS) I/O lines, useful for connecting FMC compliant expansion boards, and four single-ended general purpose I/O lines.

For the pinout of the SO-DIMM connector, please refer to: downloads.dsp-sys.de/XynergyXS/PinoutXynergyXS.pdf

A break-out board with all pins accessible at 100mil header plus JTAG headers is also available.

More information on this product can be found at https://dsp-sys.de/redir/XynergyXS



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## **Specifications:**

**Power consumption:** 3 Watts\*) @ 3.3V (alternate  $V_{IO}$  for the FPGA is 2.5V (Bank 0 & 2))

Micro-Controller: STM32F417 (F407, F437 optional )

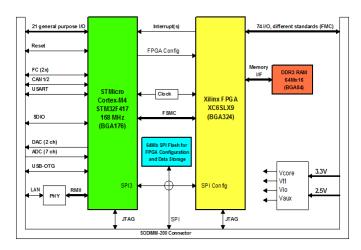
FPGA: Spartan-6 XC6SLX16 (XC6SLX45 optional)

External Memory: 128 MBytes DDR3, 64 Mbit SPI flash

 $\mbox{\rm I/O:}$  Up to 130 general purpose I/O pins, supporting different I/O standards and protocols (see text)

**Physical Dimensions:** 67.6 x 30.0 x 6mm (SO-DIMM200) **Weight:** approx. 6grams

Matching Socket: e.g., TE Connectivity 1473005-4 Bottom/Top Component Height: 2.0/2.0mm (max.) \*) depending on the application



Simplified Xynergy<sup>XS</sup> Block Diagram

## **Typical applications:**

Point of Sale (PoS),Industrial Control, Industrial Imaging, Motion Control, M2M Communication etc.

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